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Product Change Notification - B2CD200006 - JAON-23PXEI807

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CCB 1737.09 Final Notice: Rele		Analog (Linear & Mixed Signal) AND Interface									
	CCB 1737.09 Final Notice: Release to production of listed Micrel Amplifier product type										
manufactured with the B2CD2 PCN Status: Final Notification											
Microchip Parts Affected: Please open the attachments fo	Microchip Parts Affected: Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CF										
NOTE: For your convenience M	NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).										
Description of Change: Release to production of listed I technology to Microchip Fab.	Release to production of listed Micrel Amplifier product type manufactured with the B2CD2 process										
NOTE: Please review the FAQ	NOTE: Please review the FAQ linked here for additional information about this change.										
Pre Change: Fabricated at Micrel fabrication	Pre Change: Fabricated at Micrel fabrication site (San Jose, CA, USA) using 6 inch wafers.										
Post Change: Fabricated at Microchip fabricat	Post Change: Fabricated at Microchip fabrication site using 8 inch wafers.										
Pre and Post Change Summa	Pre and Post Change Summary:										
	Pre Change	Post Change									
Fab Site	(San Jose, CA, USA)	Microchip fabrication site									
Wafer Size	6 inch wafers	8 inch wafers									
	Final Notification Note: This final PCN only pertailissued for this combination of p Microchip Parts Affected: Please open the attachments for NOTE: For your convenience M Description of Change: Release to production of listed litechnology to Microchip Fab. NOTE: Please review the FAQ Pre Change: Fabricated at Micrel fabrication Post Change: Fabricated at Microchip fabrication Pre and Post Change Summa Fab Site	Final Notification Note: This final PCN only pertains to the products listed in this issued for this combination of product type and process technol Microchip Parts Affected: Please open the attachments found in the attachments field be NOTE: For your convenience Microchip includes identical files Description of Change: Release to production of listed Micrel Amplifier product type m technology to Microchip Fab. NOTE: Please review the FAQ linked here for additional inform Pre Change: Fabricated at Micrel fabrication site (San Jose, CA, USA) using Post Change: Fabricated at Microchip fabrication site using 8 inch wafers. Pre and Post Change Summary: Image: Fab Site Micrel fabrication site (San Jose, CA, USA)									

Impacts to Data Sheet: None

Reason for Change:

To improve productivity with the closure of the Micrel fab as part of the integration of Micrel and Microchip.

Change Implementation Status: In Progress

Estimated First Ship Date:

As identified for each CPN listed in the attached parts list.

Summary Time Table of notable events to date:

	:	Sep	oten 201	nbe 5	r	->	May 2016			->	September 2016					October 2016				
Workweek	36	37	38	39	40		18	19	20	21		35	36	37	38	39	40	41	42	43
Initial PCN Issue Date																				
CYER- 31JLEX869	х																			
Qual Report Available																				
JAON- 23PXEI807										Х										
Final PCN Issue Date																				
JAON- 23PXEI807- B2CD200006												х								
Estimated First Ship Date																		As listed in the attached parts list.		

Markings to Distinguish Revised from Unrevised Devices: Traceability code and shipping label see FAQ.

Revision History:

September 1, 2015: Issued initial notification as PCN number CYER-31JLEX869.

May 27, 2016: Issued intermediate notification as PCN number JAON-23PXEI807. Attached the Qualification Report. Revised the estimated first ship date (EFSD) to inform that the EFSD will be revealed in the final PCN.

August 29, 2016: Issued final notification as PCN number JAON-23PXEI807-B2CD200006 for listed Micrel's Amplifier products manufactured with the B2CD2 process technology. Provided estimated first ship date (EFSD) for each CPN listed in the attached parts list.

The change described in this PCN does not alter Micrel's or Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_JAON-23PXEI807_Qual Report.pdf PCN_JAON-23PXEI807-B2CD200006_Affected_CPN.pdf PCN_JAON-23PXEI807-B2CD200006_Affected_CPN.xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

PCN_JAON-23PXEI807-B2CD200006							
CATALOG_PART_NBR	Estimated First Ship Date (EFSD)						
MIC7122YMM	October 10, 2016						
MIC7122YMM-TR	October 10, 2016						